

ECOFREC™ 320



VOC FREE, NO-CLEAN FLUX HIGH SOLDERING EFFICIENCY

BENEFITS

ECOFREC™ 320 is a low residue, no-clean, VOC (Volatile Organic Compound) free flux, for lead and lead free application.

- Excellent wettability and hole filling on any finish
- No solder ball, no alloy projection
- Non visible residue
- High reliability : high SIR values

VOC free flux: zero solvent, not flammable as opposed to some other so-called VOC free fluxes on the market

SPECIFICATIONS

Flux appearance	Colorless liquid
Density 20°C (g/cm ³)	1,005 – 1,013
Solid content (%)	3,5
Acid index (mg KOH/g)	32
Halogen content	no halogen
Flash point	none

CHARACTERISTICS

The activation system of **ECOFREC™ 320** is eliminated after wave soldering.

- Free of halide (Fluoride, Chloride, Bromide) and halogen
- PCB cleaning after soldering is not necessary due to its very low solids content.

Standards tests	Results	Procedures
Flux Classification	ORL0	ANSI/J-STD-004
	2.1.1	ISO 9454
SIR (IPC)	pass	ANSI/J-STD-004
Copper mirror	pass	ANSI/J-STD-004
Chromate paper	pass	ANSI/J-STD-004

PROCESS PARAMETERS

ECOFREC™ 320 must be applied by spray.

Topside preheat temperature of 110 to 130°C is recommended to boil off the water and non-volatile solvents before entering wave soldering.

The temperatures obtained during preheating and solder wave will eliminate the residue to give good cosmetics.

Unlike alcohol-based fluxes ECOFREC™ 320 is a ready to use flux: it does not require acid index and density control.

Process Guideline

	SAC 305/387/405 & SnCu0.7	SnPb 63/37
Flux Amount Deposit	20 - 80 g/m ²	20 - 80 g/m ²
Preheating PCB Top Side	120°C maximum	120°C maximum
PCB Bottom Side	145°C maximum	145°C maximum
Conveyor Angle	4 - 7° (7° typique)	4 - 7° (7° typique)
Conveyor Speed	0.8 - 1.8 m/min (1,1 - 1,4m/min typique)	0,8 - 2,0 m/min (1,1 - 1,4 m/min typique)
Contact time Main Wave	2.5 - 4 s	2.5 - 4 s
Chip Wave	0.5 - 1 s	0.5 - 1 s
Solder Bath Temperature	255 - 270°C (260 - 265°C pour SAC 270°C pour SnCu)	245 - 255°C

This guideline is the result of laboratory test and process optimisation at production lines. This information's goal is mainly to make the flux implementation easier. The actual settings may vary depending on the actual products being run, the equipments, components and boards being used, etc... The optimum parameters may be slightly different from the table above.

Monitoring

As the ECOFREC™ 320 is applied only by spray in closed systems, no solvent evaporation should occur. So the ECOFREC™ 320 properties should not change during its use, then flux control is usually not necessary.

Cleaning

After soldering, the flux residue remaining of ECOFREC™ 320 does not have to be removed by a cleaning operation as it is chemically inert. However, if cleaning is required, the residue left after reflow can be easily removed if needed with a large range of cleaning solutions, such as detergents, hydro-carbonated solvents or halogenated solvents, all included in the INVENTEC cleaning range.

PROCESS Type	INVENTEC Defluxing solutions
Manual	Topklean™ EL10F/ Topklean™ EL60/ Quicksolv™ DEF90 EL
Aqueous system (Immersion or spray)	Promoclean™ DISPER 605 and DISPER 607
Co-solvent system	Topklean™ EL 20 series
Under vacuum system	Topklean™ EL 20D
Mono-solvent (Azeotropic)	Promosolv™ 70ES

PACKAGING, STORAGE & SHELF LIFE

To ensure the best product performance, the recommended storage temperature range is room temperature. Avoid storage less than 0°C.

Plastic drum	20L	12 months
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HSE

Use in well-ventilated areas. Safety glasses and gloves should always be worn when handling the flux.

No issues when used as recommended.

Please refer to Material Safety Data Sheet before use.

INVENTEC Material Safety Data sheets can be found at www.quickfds.com

Although the conformity to ROHS 2011/65UE applies EQUIPMENT put on the market and not a component in particular, we warranty that this product contains less than 0.1% of mercury, lead, chromium VI, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE) and less than 0.01% for the cadmium, in accordance with the decision of The European Commission dated 18/08/2005, fixing the maximal concentration values.

This data is based on information that the manufacturer believe to be reliable and offered in good faith. In no event will INVENTEC be responsible for special, incidental and consequential damages. The user is responsible to the Administrative Authorities (regulations for the protection of the Environment) for the conformity of his installation.

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